

2022 / 2023 Tower Semiconductor MPW Schedule

|   | Fab           |  | Tape-In  | Ship Date |
|---|---------------|--|----------|-----------|
| SB*18<br>B5004  | NPB - Fab 3   | SiGe BiCMOS 0.18um   | 04/05/22 | 10/11/22  |
| <i>Please contact your sales representative for information on fast track processing.</i> |               |  |          |           |
| PH18MA<br>B5006   | NPB - Fab 3   | SiPho 0.18um   | 05/31/22 | 10/14/22  |
| SB*18<br>B5007  | NPB - Fab 3   | SiGe BiCMOS 0.18um   | 06/14/22 | 12/20/22  |
| <i>Please contact your sales representative for information on fast track processing.</i> |               |  |          |           |
| SB*18<br>B5009  | NPB - Fab 3   | SiGe BiCMOS 0.18um   | 08/09/22 | 02/14/23  |
| <i>Please contact your sales representative for information on fast track processing.</i> |               |  |          |           |
| 22nd MPW<br>Tonami, Japan   | TPSCo - Fab 5 | TS18<br>CMOS 0.18u & 0.16u, PM, PM_SOI                                     | 08/29/22 |           |
| SB*/CA/13*<br>B5011   | NPB - Fab 3   | SiGe BiCMOS / RF CMOS 0.13um   | 08/30/22 | 04/26/23  |
| <i>Please contact your sales representative for information on fast track processing.</i> |               |  |          |           |
| PH18DAZ<br>B5008  | NPB - Fab 3   | SiPho 0.18um   | 08/30/22 | 03/03/23  |
| CA18<br>B5012   | NPB - Fab 3   | RFCMOS 0.18um  | 09/13/22 | 02/21/23  |
| <i>Please contact your sales representative for information on fast track processing.</i> |               |  |          |           |
| CS18*<br>B5010  | MH - Fab 2    | CMOS-SOI 0.18um  | 09/20/22 |           |
| 22nd MPW<br>Uozu, Japan   | TPSCo - Fab 7 | CMOS, PM & RFCMOS<br>65nm : TPS65SLA/SLC,<br>TPS65PMA/PMB/MSA/MSB, TPS65RF | 09/26/22 |           |
| SB*18<br>B5013  | NPB - Fab 3   | SiGe BiCMOS 0.18um   | 10/04/22 | 04/11/23  |
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| 23rd MPW<br>Uozu, Japan   | TPSCo - Fab 7 | RFSOI<br>65nm:TPS90RSB2, TPS65RSA2/RSB | 10/17/22 |           |
| PH18M*<br>B5014   | NPB - Fab 3   | SiPho 0.18um                           | 11/01/22 | 03/17/23  |
| PH18DAZ<br>B5258  | NPB - Fab 3   | SiPho 0.18um                           | 11/08/22 | 05/12/23  |
| SH422T18NOV   | MH - Fab 2    | CIS 0.18um Image Sensor                | 11/14/22 |           |
|   |               | CMOS+ 0.16um, 0.18um RF, RFID, PM      | 11/21/22 |           |
| 23rd MPW<br>Tonami, Japan   | TPSCo - Fab 5 | TS18<br>CMOS 0.18u & 0.16u, PM, PM_SOI | 11/28/22 |           |
| SB*18<br>B5015  | NPB - Fab 3   | SiGe BiCMOS 0.18um                     | 12/06/22 | 06/13/23  |
| <i>Please contact your sales representative for information on fast track processing.</i> |               |  |          |           |
| CA18<br>B5300   | NPB - Fab 3   | RFCMOS 0.18um                          | 01/24/23 | 07/07/23  |
| <i>Please contact your sales representative for information on fast track processing.</i> |               |  |          |           |
| SB*18<br>B5301  | NPB - Fab 3   | SiGe BiCMOS 0.18um                     | 02/07/23 | 08/17/23  |
| <i>Please contact your sales representative for information on fast track processing.</i> |               |  |          |           |
| SH123T18FEB   | MH - Fab 2    | 0.18 BSI, Stacking on 0.13             | 02/14/23 |           |
| PH18M*<br>B5302   | NPB - Fab 3   | SiPho 0.18um                           | 02/21/23 | 07/07/23  |
| 24th MPW<br>Tonami, Japan   | TPSCo - Fab 5 | TS18<br>CMOS 0.18u & 0.16u, PM, PM_SOI | 02/27/23 |           |
| SB*/CA/13*<br>B5303   | NPB - Fab 3   | SiGe BiCMOS / RF CMOS 0.13um           | 03/07/23 | 11/03/23  |
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| 24th MPW<br>Uozu, Japan   | TPSCo - Fab 7 | CMOS,PM & RFCMOS, 65nm :<br>TPS65SLA/SLC, TPS65PMA/PMB/MSA/MSB, TPS65RF   | 03/20/23             |           |
| PH18DAZ<br>B5304          | NPB - Fab 3   | SiPho 0.18um  | 03/21/23             | 09/22/23  |
| SB*18<br>B5305            | NPB - Fab 3   | SiGe BiCMOS 0.18um<br><i>Please contact your sales representative for information on fast track processing.</i>           | 04/04/23             | 10/10/23  |
| 25th MPW<br>Uozu, Japan   | TPSCo - Fab 7 | RFSOI, 65nm :<br>TPS90RSB2, TPS65RSA2/RSB/RSB2  | 04/10/23             |           |
| CS18*<br>B5306            | MH - Fab 2    | CMOS-SOI 0.18um   | 05/02/23             |           |
| CA18<br>B5307             | NPB - Fab 3   | RFCMOS 0.18um<br><i>Please contact your sales representative for information on fast track processing.</i>                | 05/16/23             | 10/27/23  |
| SH223T18MAY               | MH - Fab 2    | CIS 0.18um Image Sensor<br>CMOS+ 0.16um, 0.18um RF, RFID, PM  | 05/16/23<br>05/23/23 |           |
| 25th MPW<br>Tonami, Japan | TPSCo - Fab 5 | TS18<br>CMOS 0.18u & 0.16u, PM, PM_SOI  | 05/29/23             |           |
| PH18M*<br>B5308           | NPB - Fab 3   | SiPho 0.18um  | 05/30/23             | 10/13/23  |
| SB*18<br>B5309            | NPB - Fab 3   | SiGe BiCMOS 0.18um<br><i>Please contact your sales representative for information on fast track processing.</i>           | 06/06/23             | 12/14/23  |
| SB*/CA/13*<br>B5310       | NPB - Fab 3   | SiGe BiCMOS / RF CMOS 0.13um<br><i>Please contact your sales representative for information on fast track processing.</i> | 06/20/23             | 02/16/24  |
| SB*18<br>B5311            | NPB - Fab 3   | SiGe BiCMOS 0.18um<br><i>Please contact your sales representative for information on fast track processing.</i>           | 08/01/23             | 02/08/24  |

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| SH323T18AUG               | MH - Fab 2    | CIS 0.18um Image Sensor   | 08/08/23 |           |
|                           |               | CMOS+ 0.16um, 0.18um RF, RFID, PM   | 08/15/23 |           |
| 26th MPW<br>Tonami, Japan | TPSCo - Fab 5 | TS18  | 08/28/23 |           |
|                           |               | CMOS 0.18u & 0.16u, PM, PM_SOI  |          |           |
| PH18M*<br>B5312           | NPB - Fab 3   | SiPho 0.18um  | 08/29/23 | 01/12/24  |
| CS18*<br>B5313            | MH - Fab 2    | CMOS-SOI 0.18um   | 09/12/23 |           |
|                           |               |   |          |           |
| 26th MPW<br>Uozu, Japan   | TPSCo - Fab 7 | CMOS,PM & RFCMOS, 65nm :  | 09/25/23 |           |
|                           |               | TPS65SLA/SLC, TPS65PMA/PMB/MSA/MSB, TPS65RF   |          |           |
| SB*18<br>B5314            | NPB - Fab 3   | SiGe BiCMOS 0.18um  | 09/26/23 | 04/04/24  |
|                           |               | <i>Please contact your sales representative for information on fast track processing.</i> |          |           |
| PH18DAZ<br>B5315          | NPB - Fab 3   | SiPho 0.18um  | 10/10/23 | 04/12/24  |
| 27th MPW<br>Uozu, Japan   | TPSCo - Fab 7 | RFSOI, 65nm :   | 10/16/23 |           |
|                           |               | TPS90RSB2, TPS65RSA2/RSB/RSB2   |          |           |
| CA18<br>B5317             | NPB - Fab 3   | RFCMOS 0.18um   | 11/07/23 | 04/19/24  |
|                           |               | <i>Please contact your sales representative for information on fast track processing.</i> |          |           |
| SH423T18NOV               | MH - Fab 2    | CIS 0.18um Image Sensor   | 11/14/23 |           |
|                           |               | CMOS+ 0.16um, 0.18um RF, RFID, PM   | 11/21/23 |           |
| 27th MPW<br>Tonami, Japan | TPSCo - Fab 5 | TS18  | 11/27/23 |           |
|                           |               | CMOS 0.18u & 0.16u, PM, PM_SOI  |          |           |
| PH18M*<br>B5318           | NPB - Fab 3   | SiPho 0.18um  | 11/28/23 | 04/12/24  |

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| SB*18 | NPB - Fab 3   | SiGe BiCMOS 0.18um | 12/12/23 | 06/21/24  |
| B5319 | <i>Please contact your sales representative for information on fast track processing.</i> |                    |          |           |

Notes : "Shuttles" (SH\*) are run at Fab 2

\* 0.13u MH - fab 2 Shuttle / MPW slots will be considered per needs

Please contact your customer account manager for additional information.

Fab2 -- Tower Semiconductor 200mm wafer fabrication facility at Migdal Ha'emek, Israel

Fab3 -- Tower Semiconductor 200mm wafer fabrication facility at Newport Beach, CA

Fab5 -- Tower Semiconductor 200mm wafer fabrication facility at Tonami, Japan

Fab7 -- Tower Semiconductor 300mm wafer fabrication facility at Uozu, Japan